

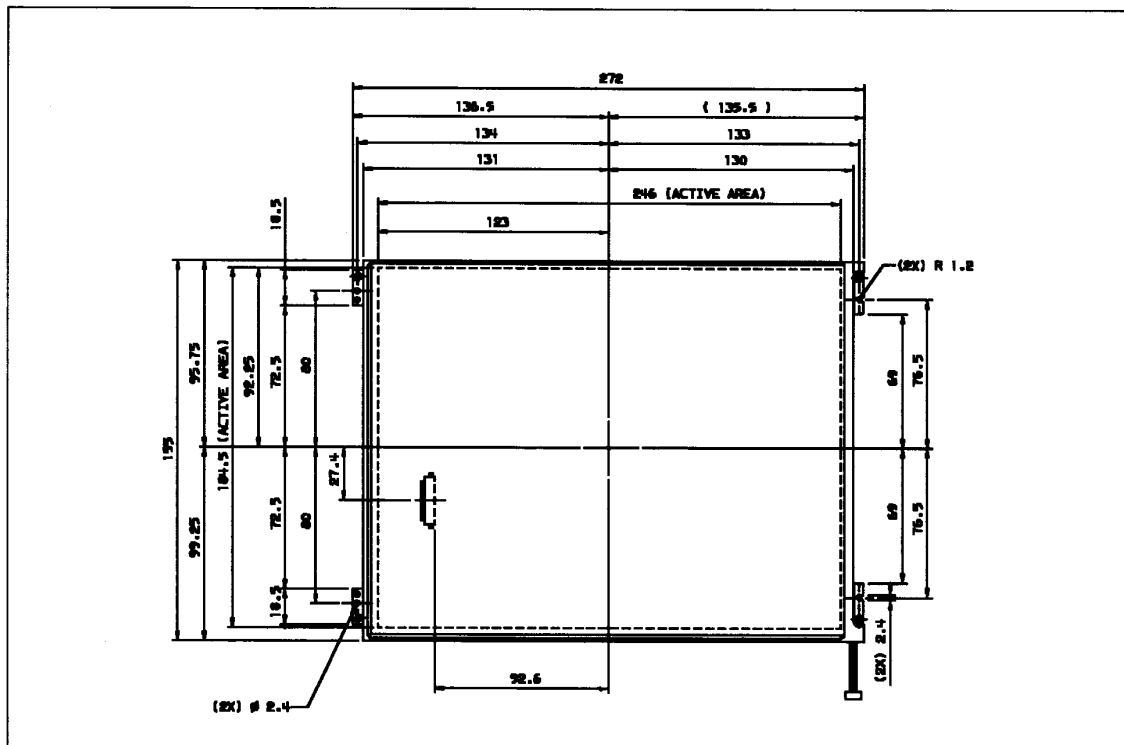


ITSV51X

12.1 inch SVGA Color TFT LCD Module

Specification Summary

◆ Screen Diagonal	30.8cm(12.1")
◆ Active Area	246.0mm(H) x 184.5mm(V)
◆ Pixel Format	800 x RGB x 600
◆ Pixel Pitch	0.3075(per one triad)mm x 0.3075mm
◆ Typical White Luminance	70 cd/m ² Typ.
◆ Power Consumption (VDD + VL)	1.9W Typ.
◆ Weight	450 grams Typ. (w/o inverter)
◆ Physical Size	272mm x 195mm x 7.5mm
◆ Contrast Ratio	100 : 1 Typ.
◆ Supported Colors	262k colors (6bit/color)





ITSV51X

30.8cm(12.1 inch)SVGA(800x600) Color TFT LCD Module

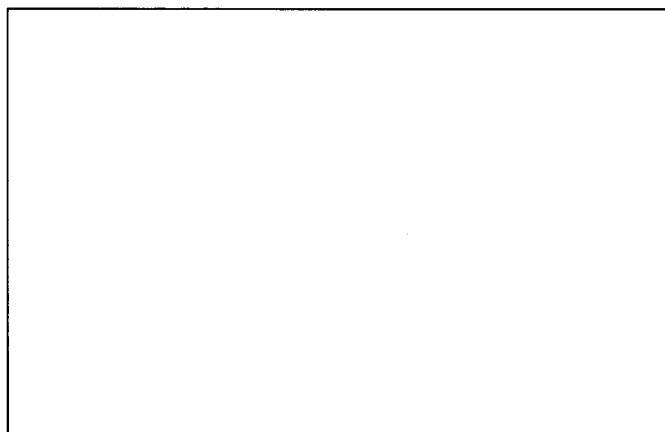
ITSV51X is a TFT LCD color module to be designed to realize the largest screen on A4 size notebook style personal computer. In addition to its large screen, the characteristics of this module are light weight, slim/thin outline, low power consumption and high resolution of SVGA(800x600) capability.

Features

- 30.8cm(12.1 inch) diagonal
- Native 262k colors (R/G/B 6bit each)
- SVGA 800 x 600 pixels
- Low Reflection (Black Matrix)
- Size : 272mm x 195mm x 7.5mm typ.
- Weight : 450 g typ.
- Power Consumption : 2.1 W typ.

Applications

- Notebook PCs
- Monitors





Characteristics Summary

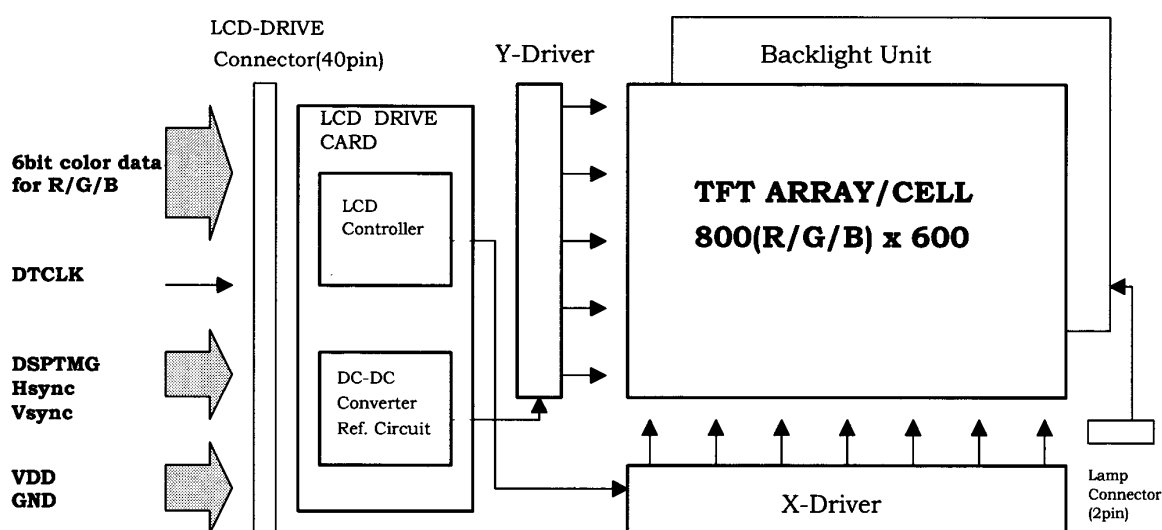
Screen Diagonal	30.8cm(12.1")
Active Area	246.0mm(H) x 184.5mm(V)
Pixel Format	800(x3) x 600
Pixel Pitch	0.3075(per one triad) x 0.3075
Pixel Arrangement	R,G,B Vertical Stripe
Display Mode	Normally White
White Luminance	70 cd/m ² Typ. (CFL Discharge Current = 2.8 mA _{RMS})
Contrast Ratio	100 : 1 Typ.
Optical Rise Time/Fall Time	35 msec. Typ. at 25 degC
Nominal Input Voltage VDD	+3.3V Typ.
Power Consumption (VDD line + Lamp input line)	2.1W typ.
Weight	450 grams typ.
Physical Size	272mm x 195mm x 7.5mm typ.
Electrical Interface	Digital Video Signals(6-bit for each color R/G/B) Sync. Signal (x4)
Supported Colors	Native 262k colors
Temperature Range	
Operating	+0 to +50 degC
Storage	-20 to +60 degC



Absolute Maximum Ratings

Rating	Symbol	Value	Unit	Conditions
Supply Voltage	VDD	-0.3 to +3.9	V	Lamp Ignition Voltage at 0 degC
	Vcfl	1300	Vrms	
Lamp Current	Icfl	6.5	mA rms	Exclude inrush current
Input Voltage	VIN1	-0.3 to Vdd+0.3	V	
Shock		50	G	18ms
Vibration		1.5	G	10-200Hz
Storage Temperature	TST	-20 to + 60	degC	At the glass surface
Operation Temperature	TOP	0 to +50	degC	At the glass surface
Operation Humidity		8 to 95	%RH	Max wet bulb temp. 29 degC No condensation

Block Diagram





Signal Interface

		Supplier Name	Supplier's Part Number
LCD Drive Connector		JAE	IL-FHR-B40S-HF(for 0.5mm pitch FPC)
Corresponding Connector			0.5mm pitch FPC
Pin No.	Signal Name	Description	
15	+RED5	Red Data 5	(MSB)
14	+RED4	Red Data 4	
13	+RED3	Red Data 3	
11	+RED2	Red Data 2	
10	+RED1	Red Data 1	
9	+RED0	Red Data 0	(LSB)
		Red-Pixel-Data	Each red pixel's data consists of these 6 bits pixel data
25	+GREEN5	Green Data 5	(MSB)
24	+GREEN4	Green Data 4	
23	+GREEN3	Green Data 3	
21	+GREEN2	Green Data 2	
20	+GREEN1	Green Data 1	
19	+GREEN0	Green Data 0	(LSB)
		Green-Pixel-Data	Each green pixel's data consists of these 6 bits pixel data
35	+BLUE5	Blue Data 5	(MSB)
34	+BLUE4	Blue Data 4	
33	+BLUE3	Blue Data 3	
31	+BLUE2	Blue Data 2	
30	+BLUE1	Blue Data 1	
29	+BLUE0	Blue Data 0	(LSB)
		Blue-Pixel-Data	Each blue pixel's data consists of these 6 bits pixel data



2	-DTCLK	Data Clock	The typical frequency is 40.00MHz. The signal is used to strobe the pixel data and +DSPTMG signals. All pixel data shall be valid at the falling edge when the +DSPTMG signal is high.
37	+DSPTMG	Display Timing	This signal strobed at the falling edge of -DTCLK. When the signal is high, the pixel data shall be valid to be displayed.
5	VSYN	Vertical Sync	The signal is synchronized to -DTCLK.
4	HSYN	Horizontal Sync	The signal is synchronized to -DTCLK.
38,39	VDD	+3.3V	
1,3,6,7,8,12,16,17 18,22,26,27,28,32 36	GND	Signal Ground	
40		Reserved	No connection (Signal reserved for test)

Note: Output signals from system shall be low or Hi-Z state when VDD is off.



Signal Interface for Lamp

		Supplier Name	Supplier's Part Number
Lamp Connector		JST	BHR-03VS-1
Pin No.	Signal Name	Description	
1	Lamp High		
3	Lamp Low		

Signal Specification

R/G/B,DTCLK,DSPTMG,H/VSNC signal specification				
Parameter	Condition	Min.	Max.	Unit
Vih	High level input voltage	2.0	Vdd+0.3	V
Vil	Low level input voltage	0	0.8	V
Iih	High level input current	—	50	uA
Iil	Low level input current	—	-50	uA

Lamp Interface Specification

1) Absolute Maximum Rating

Parameter Name	Symbol	Value	Unit	Note
CFL Discharge Current	I _{CFL}	6.5 Max	[mA _{RMS}]	Exclude inrush current
CFL Inrush Current	IR _{CFL}	30 Max	[mA _{0-P}]	T = 50 Max. [mSec]



2) Parameter Guideline for CFL Inverter

Parameter Name	Symbol	Min.	Typ.	Max.	Unit	Note
CFL Kick-off Voltage	V_s	-	-	900	[V _{RMS}]	$T_{amb}=25\text{ degC}^{*4}$
		-	-	1,300		$T_{amb}=0\text{ degC}^{*4}$
CFL Discharge Current	I_{CFL}	2.0 ^{*6}	-	6.0	[mA _{RMS}]	Total operating range
		-	2.8	-		Screen 70 [cd/m ²], 25degC
CFL Discharge Voltage	V_{CFL}	-	500	-	[V _{RMS}]	Screen 70 [cd/m ²], $T_{amb}=25\text{ degC}$
CFL Power Consumption	P_{CFL}	-	1.4	-	[W]	Screen 70 [cd/m ²], $T_{amb}=25\text{ degC}$
CFL Discharge Frequency	F_{CFL}	30	40	60 ^{*6}	[kHz]	Reference ^{*5}

Note

- *1 All of characteristics listed 2) are measured under the condition using the IBM Test inverter .
- *2 It is recommended to check the inverter carefully. Sometimes, interfering noise stripes appear on the screen, and substandard luminance or flicker at low power happen.
- *3 It is suggested to check safety circuit very carefully. Impedance of CFL, for instance, becomes more than 1 [M ohm] when CFL is damaged.
- *4 Generally, CFL has some amount of delay time after applying kick-off voltage. It is recommended to keep on applying kick-off voltage for 1 [Sec] until dischargement.
- *5 CFL discharge frequency must be carefully chosen so as not to produce interfering noise stripes on the screen.
- *6 Reducing CFL current increases CFL discharge voltage and generally increses CFL discharge frequency. So all the parameters of an inverter should be carefully designed so as not to produce too much leakage current from high-voltage output of the inverter.



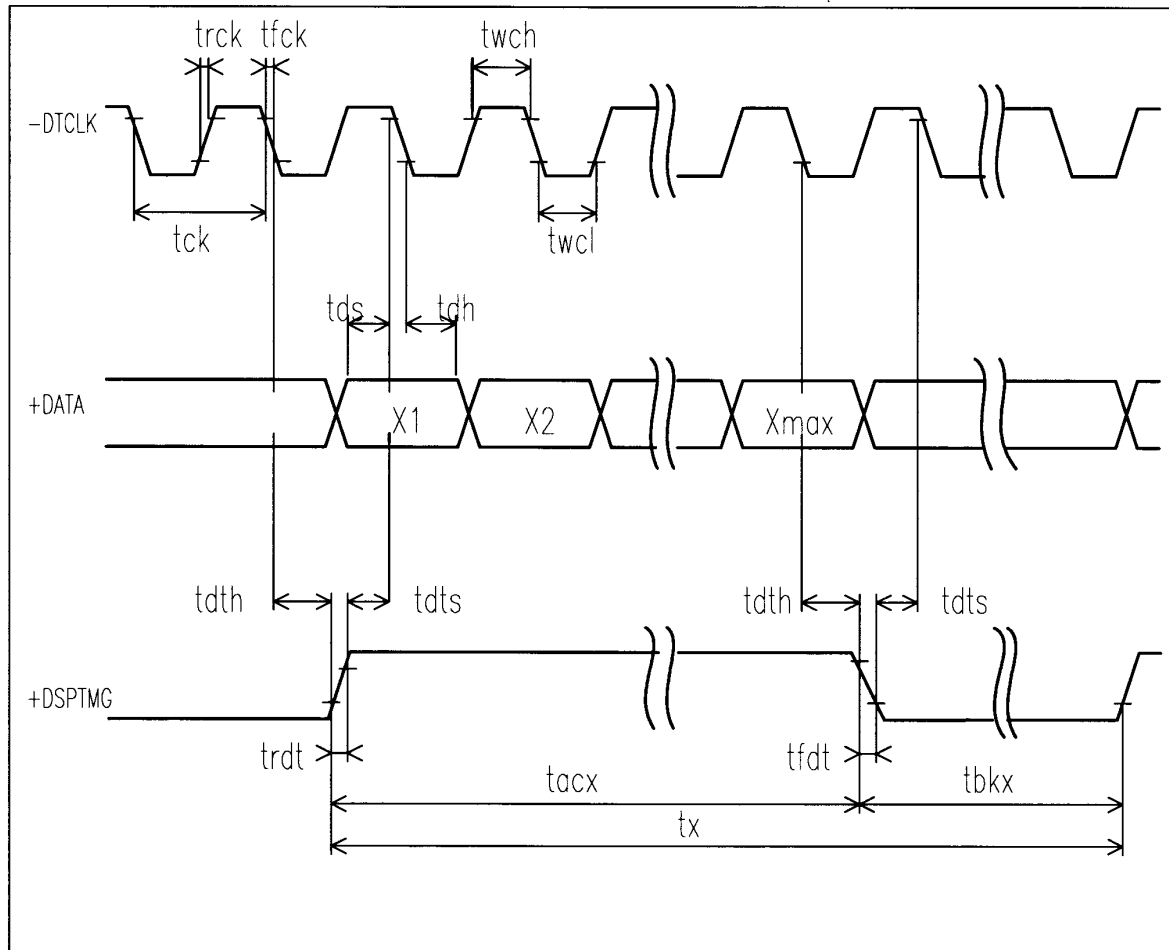
Interface Timing

Basically ,interface timings should match the VESA 800 x 600 60Hz manufacturing guideline timing.

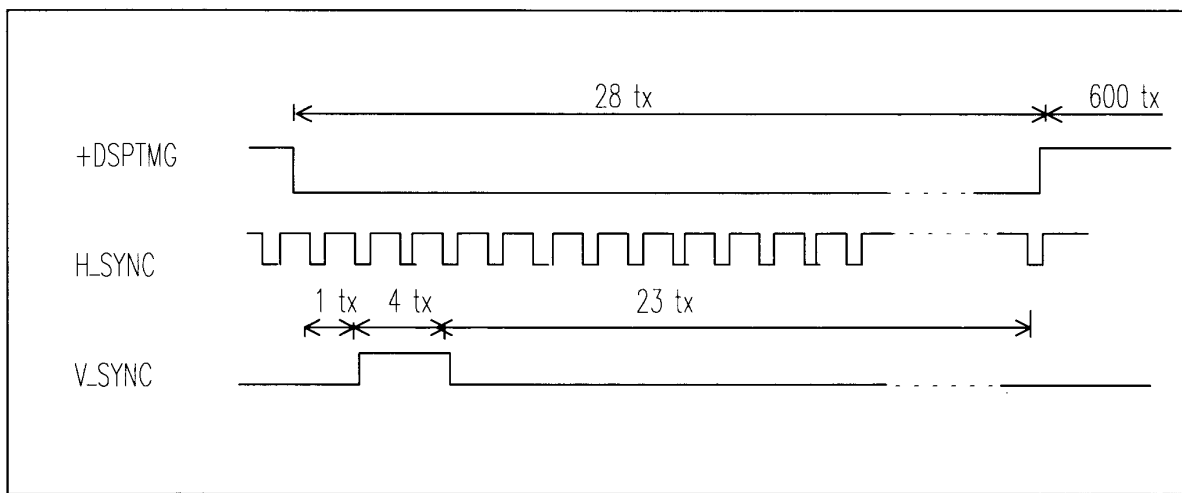
Symbol	Signal Description	MIN	TYP	MAX	UNIT
f_{dck}	DTCLK frequency	36.00	40.00	40.20	MHz
t_{ck}	DTCLK cycle time	27.77	25.00	24.88	nsec
t_{wcl}	DTCLK low width	5.00			nsec
t_{wch}	DTCLK high width	5.00			nsec
t_{rck}	DTCLK rise time			3.00	nsec
t_{fck}	DTCLK fall time			3.00	nsec
t_{ds}	Data set up time	5.00			nsec
t_{dh}	Data hold time	5.00			nsec
t_{rdt}	DSPTMG rise time	5.00			nsec
t_{fdt}	DSPTMG fall time	5.00			nsec
t_{dts}	DSPTMG set up time	5.00			nsec
t_{dth}	DSPTMG hold time	5.00			nsec
t_x	X total time	848	1056	1088	t_{ck}
t_{acx}	X active time		800		t_{ck}
t_{bkx}	X blank time	48	256	288	t_{ck}
H_{sync}	H-sync frequency	35.16	37.88	38.46	kHz
H_w	H-sync width	16	128	152	t_{ck}
t_y	Y total time	611	628	1025	t_x
t_{acy}	Y active time		600		t_x
V_{sync}	Frame rate	56.25	60.00	61.00	Hz
V_w	V-sync width	1	4	7	t_x
V_{fp}	V-sync front porch	1	1	415	t_x
V_{bp}	V-sync back porch	9	23	29	t_x



Horizontal Timing



Vertical Timing





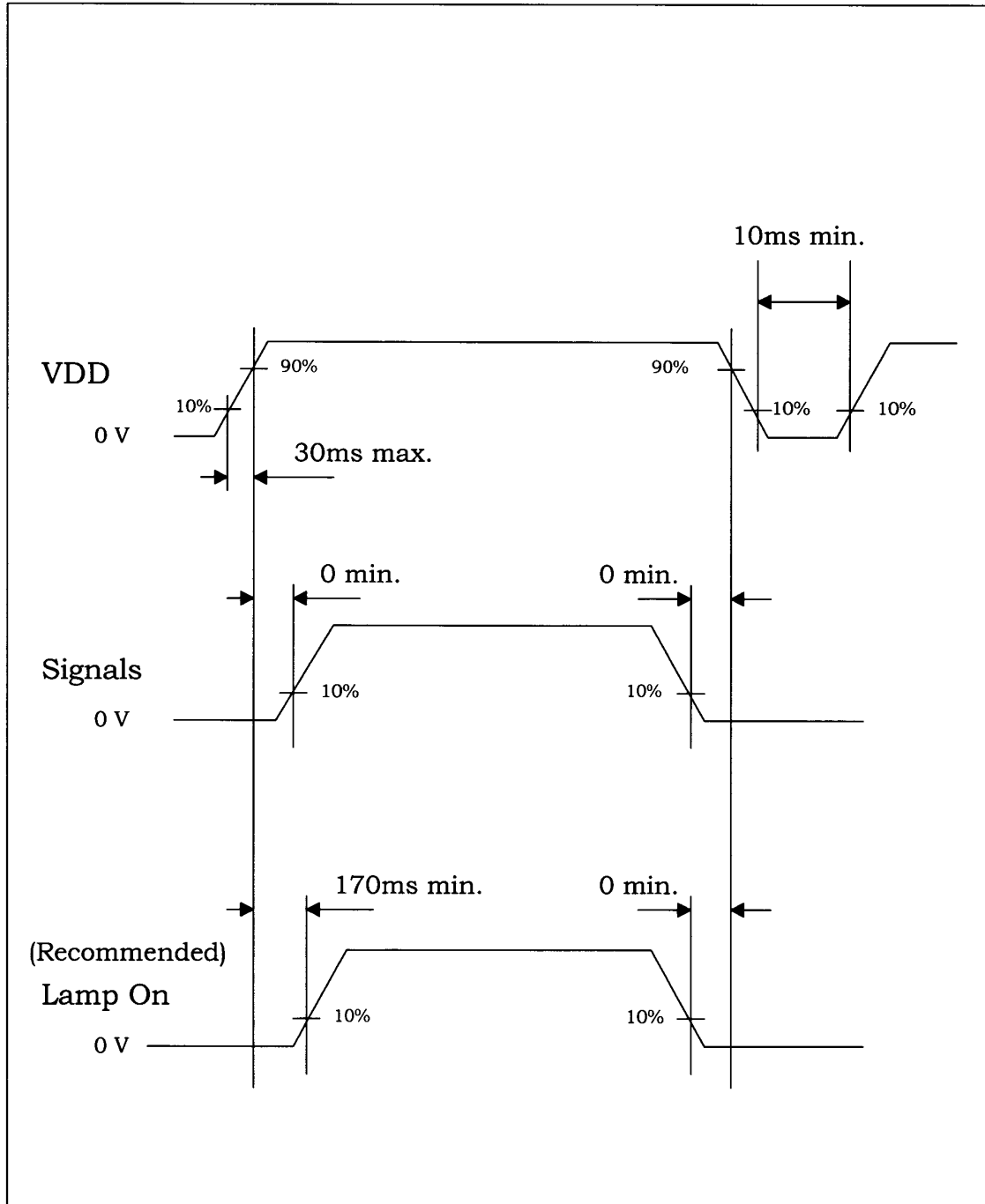
Power Requirement

SYMBOL	PARAMETER	Min.	Typ.	Max.	Unit	CONDITION
VDD	Logic/LCD Drive Voltage	+3.0	+3.3	+3.6	V	Load Capacitance 40uF
PDD	VDD Power		0.7		W	VDD=+3.3V
PL	Lamp Power(w/o inverter)		1.4		W	
PDD+PL	Total Power(w/o inverter)		2.1		W	
VDDrp	Allowable Logic/LCD Drive Ripple Voltage			100	mVp-p	
VDDns	Allowable Logic/LCD Drive Ripple Noise			100	mVp-p	

Note: This requirements shall be met with both 'All black pattern'.



Power ON/OFF sequence





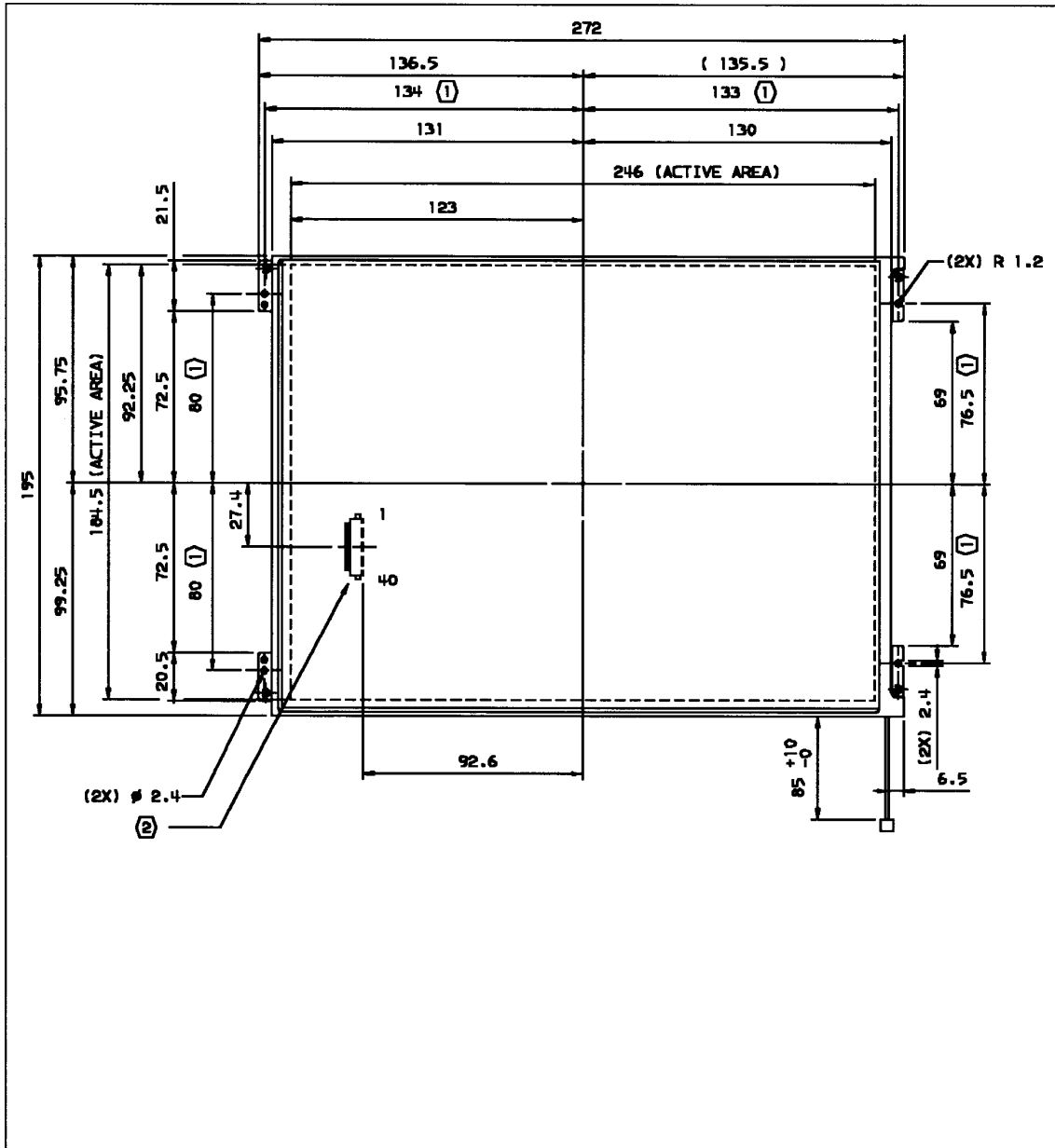
Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.

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Reference Drawing without inverter



Dimensions shown in this Drawing are Reference Only.

They are subject to change without notifications.